Optoelectronics Devices & Circuits (MEC-166)



UNIT-I

By

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M. Toch (Digital Systems) Syllabus

M. Tech. (Digital Systems) Synabus		
MEC-166	Optoelectronics Devices & Circuits	
Topics Cov	vered	
UNIT-I		
Elements a	and compound Semiconductor, Electronic Properties of semiconductor, Carrier	9
effective m	nasses and band structure, effect of temperature and pressure on bandgap, Carrier	
scattering p	phenomena, conductance processes in semiconductor, bulk and surface recombination	
phenomena	l.	
UNIT-II		
Optical Properties of semiconductor, EHP formation and recombination, absorption in		9
semiconduc	ctor, Effect of electric field on absorption, absorption in quantum wells, radiation in	
semiconduc	ctor, Deep level transitions, Augur recombination's.	
UNIT-III		
Junction th	neory, Schottky barrier and ohmic contacts, semiconductor heterojunctions, LEDs,	9
Photo Dete	ctors, Solar cells.	
UNIT-IV		
Optoelectronics modulation and switching devices: Analog and Digital modulation, Franz-		9
Keldysh an	d stark effects modulators, Electro-optic modulators.	
Optoelectro	onics Integrated Circuits (OEICs): Need for hybrid and monolithic integration, OEIC	
transmitters	s and receivers.	
Toythooks		<u> </u>

I extbooks

Semiconductor optoelectronic Devices By Pallab Bhattachrya, Prentice Hall Publications. 1.

2. Physics of Semiconductor Devices, By S.M. Sze, Wiley Publication.

Key Points

- Introduction to Optoelectronics Devices
- Energy bands in solids, E-k diagram
- Elemental and Compound Semiconductor
- Semiconductor optoelectronic materials
- Carrier effective mass
- Effect of Temperature and Pressure on bandgap
- Carrier scattering
- Effect of scattering om mobility of carriers
- Conductance process in semiconductor
- Bulk and surface recombination phenomena

Carrier scattering phenomena in Semiconductors

- The charge carrier, electron or holes in a semiconductor is usually not stationary.
- They are always in random thermal motion, thus the net displacement is zero.
- Electrons & holes within a crystal are scattered by phonons, or lattice vibration.
- There are other source of carrier scattering such as:
- Mechanism of Carrier Scattering:
- 1. Phonon or lattice Scattering
- 2. Impurity ion (dopant) Scattering
- In general anything that perturbs the periodic crystal potential in lattice which in turns alters the band edge potential will scatter carrier.

Relation b/w the relaxation time for carrier scattering & resulting mobility of carrier

- We define a scattering cross section $\sigma_s(\theta, \varphi) d\Omega$, which is the probability that an electron is scattered from $(\theta, \varphi)=0$ to some angle (θ, φ) , within an incremental solid angle $d\Omega$ as in fig 1.6.
- The total cross section is then

$$\sigma_{st} = \int \sigma_s(\theta, \phi) d\Omega \qquad (1.6)$$



Fig 1.6 (a) Scattering geometry in polar coordinates (b) motion of an electron under the influence of an electric field.

- The motion is a superposition of drift and random motion with thermal velocity.
- As the field increases, the drift component becomes more dominant.

We also define a mean time τ_c between the successive collision such that:

 $\tau_C = \frac{l}{\vartheta}$

where *l* is the mean free path and ϑ is the mean velocity. Consider *n* electrons moving with velocity ϑ in a given direction. The number of collisions, *dn*, in time *dt* is proportional to *n* and *dt*, so that

dn = -Cndt

where C is a constant of proportionality. We define

$$C = \frac{1}{\tau_C}$$

where τ_c is defined as the relaxation time. Combining

$$\frac{dn}{n} = -\frac{dt}{\tau_C}$$

which, on integration, gives

 $n = n^o e^{-t/\tau_c}$

where $n = n^{\circ}$ at t = 0. The probability that an electron has not made a collision is

The mean time between collisions is

$$\bar{t} = \frac{1}{\tau_C} \int_0^\infty t e^{-t/\tau_C} = \tau_C$$

The mean free path can also be defined as

$$\frac{1}{l} = N_{sc}\sigma_{st}$$

where N_{sc} is the density of scattering centers. Therefore,

$$\tau_C = \frac{1}{N_{sc}\sigma_{st}\vartheta}$$

Consider now an electron under the influence of an electric field and suffering collisions, as depicted in Fig. 2.6(b). At time t = 0, its velocity is ϑ_0 and the velocity ϑ at time t, when it suffers collision, is given by

$$\vartheta = \vartheta_0 - \frac{qEt}{m_e^*}$$

where E is the applied field. This equation must be averaged over all time knowing that $\frac{1}{\tau_c}e^{-t/\tau_c}$ is the probability that a collision will occur after t seconds. Thus, the time-averaged velocity is given by

$$\overline{\vartheta} = \overline{\vartheta}_0 - \frac{qE}{\tau_C m_e^*} \int_0^\infty t e^{-t/\tau_C} dt$$

$$=\overline{\vartheta}_0 - \frac{qE\tau_C}{m_e^*}$$

If the collisions are truly random, $\overline{\vartheta}_0 = 0$ and the mean drift velocity is given by

$$\overline{\vartheta} = \overline{\vartheta}_D = -\frac{qE\tau_C}{m_*^*}$$

The magnitude of the mean drift velocity per unit field is defined as mobility, such that for electrons

$$\mu_e = \frac{\overline{\vartheta}_D}{E} = -\frac{q\tau_{C_e}}{m_e^*}$$

and for holes

$$\mu_h = \frac{q\tau_{C_h}}{m_h^{\bullet}}$$

Therefore, through the effective masses, the carrier mobilities depend on the dispersion curve.

Effect of Scattering on Mobility Of Carriers

- In a very pure crystal the mobility is limited at high temperature by carrier scattering or phonon scattering.
- The lattice vibration depends on the temperature.
- It is explained by two phenomena:
- (a)Impurity scattering

(b)Lattice or phonon scattering

≻Lattice or phonon scattering:

- As the phonon moves through the crystal, the bandgap develops periodic perturbation
- As the temperature increases the lattice vibrational frequency will increase and the effect of this cause the lattice scattering.
- When the temperature increases thermal vibration increases which decreases the mobility and lattice scattering occurs.
- Due to future increase in the temperature the lattice scattering increases and mobility of carrier decrease which is given by :

>Impurity Scattering:

- Even in a pure crystals there are impurities and other electrically active defects
- Due to impurity doping in semiconductor the atoms or the electrons are deviated from the path i.e. the motion of electron will be changed and deviation path will take place.
- As the temperature will increase the effect of impurity scattering will decrease.
- When the temperature increases the mobility of the carrier increase then the carrier does not deviate from the path .

The mobility of carrier as the temperature increases impurity scattering increases is given by:

 $\mu_I \alpha T^{3/2}$

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The total mobility as a function of temperature, is then given by Mattheisen's rule as:

\frac{1}{\mu} = \frac{1}{\mu_I} + \frac{1}{\mu_P}
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Where μ_I is the mobility limited by impurity scattering and μ_P is the mobility limited by phonon scattering

Matthiessen's Rule

- The probability that a carrier will be scattered by mechanism *i* within a time period *dt* is $\frac{dt}{\tau_i}$ where τ_i is the mean time between scattering events due to mechanism *i*
- ➔ The probability that a carrier will be scattered within

a time period dt is $\sum_{t=1}^{t} \frac{dt}{\tau}$





Mobility Dependence on Doping



